

The MM70 series is a graphics board connector compatible with the MXM3.0 standard. It can be use to connect add-in MXM3.0 modules (graphics boards) in order to improve the graphics processing performance of personal computers.

Features

- ■Mating area is 0.5mm pitch, with two-layer upper and lower structure.
- Compatible with MXM3.0 standard. (Card edge type).
- Contact size: available in 2 types
 - 6.7mm height, 12.20mm depth, and 89.9mm width. (3.0mm board height)
- 4.3mm height, 12.75mm depth, and 89.9mm width. (1.5mm board height) ■Precision positioning stopper for MXM3.0 module prevents contact failure.

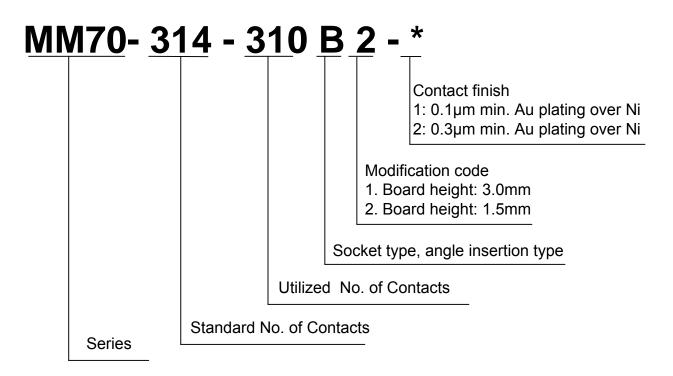
General Specifications

- ■No. of contacts: 314 pos.
- Contact resistance: 55m Ω max. (initial), 80m Ω max. (after test)
- Dielectric withstanding voltage: AC 250Vr.m.s (per minute)
- ■Rated Current: 0.5A per pin
- ■Insulation Resistance: 50M Ω min. (after test)
- Durability: 30 times
- ■Operating temperature: -40 to+80 Deg. C

Materials and Finishes

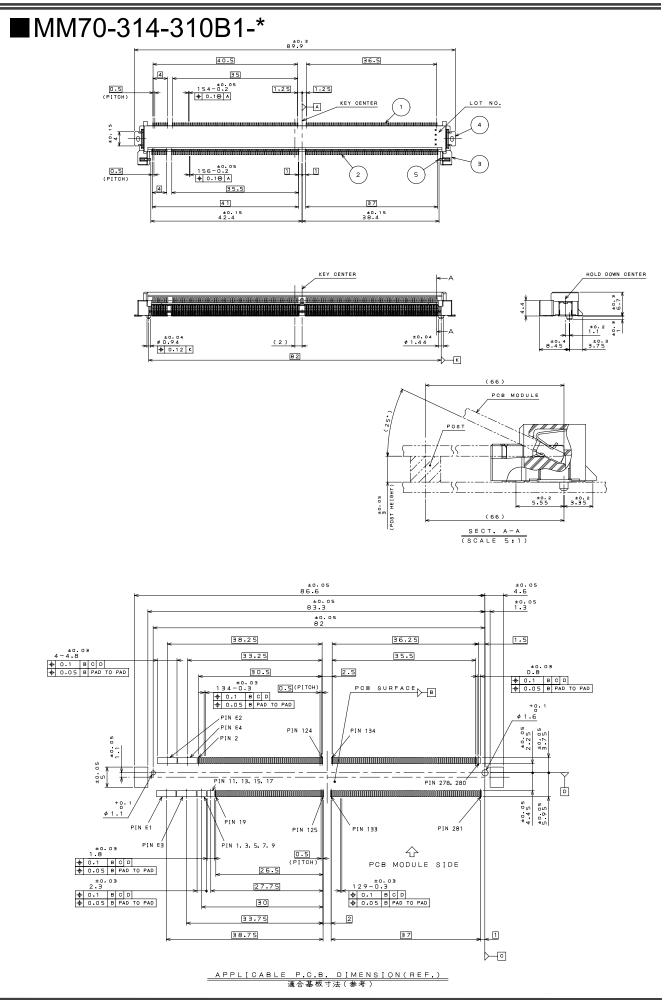
Component	Material / Finish
Insulator	Heat resistant plastic
Contact	Copper alloy / contact area: 0.1µm min. Au plating over Ni
Hold down	Copper alloy / Sn plating over Ni
Stopper	Copper alloy / Sn plating over Ni

Ordering Information

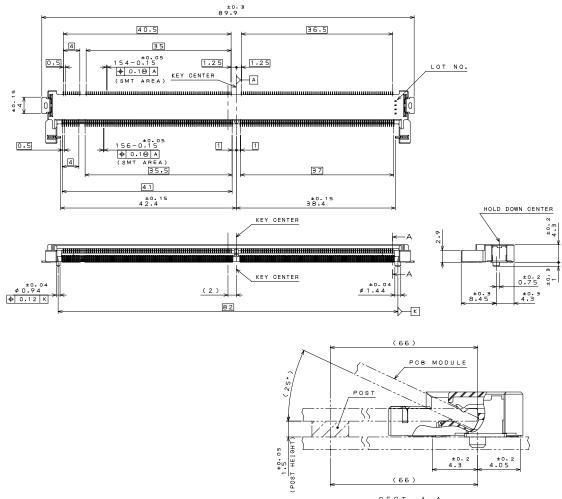


Drawing No.

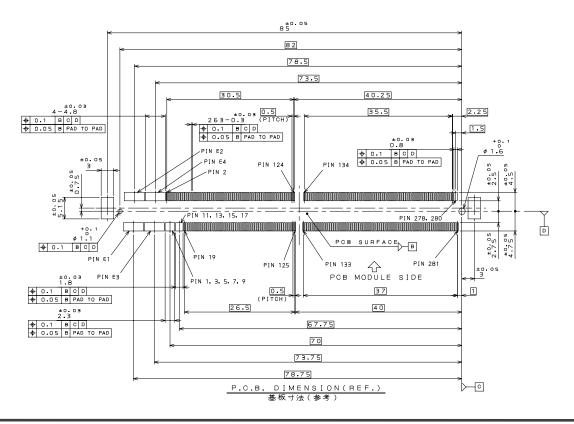
Part Number	SJ Drawing	Specification
MM70-314-310B2-1	SJ109148	JACS-10543
MM70-314-310B2-2	53109140	
MM70-314-310B1-1	SJ109265	
MM70-314-310B1-2		



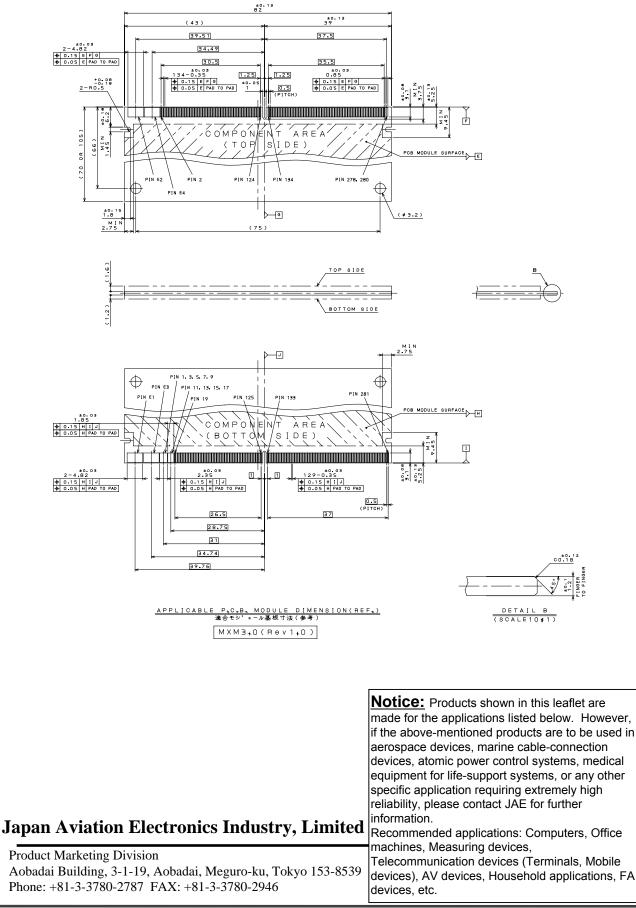
MM70-314-310B2-*







Applicable dimensions of module board (for reference)



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